

November 2009

CNY171M, CNY172M, CNY173M, CNY174M, CNY17F1M, CNY17F2M, CNY17F3M, CNY17F4M, MOC8106M, MOC8107M Phototransistor Optocouplers

Features

- UL recognized (File # E90700, Vol. 2)
- VDE recognized
 - Add option V (e.g., CNY17F2VM)
 - File #102497
- Current transfer ratio in select groups
- High BV_{CEO}: 70V minimum (CNY17XM, CNY17FXM, MOC810XM)
- Closely matched current transfer ratio (CTR) minimizes unit-to-unit variation.
- Very low coupled capacitance along with no chip to pin 6 base connection for minimum noise susceptability (CNY17FXM, MOC810XM)

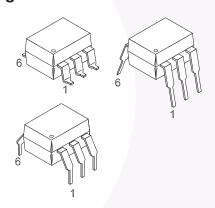
Applications

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs
- Appliance sensor systems
- Industrial controls

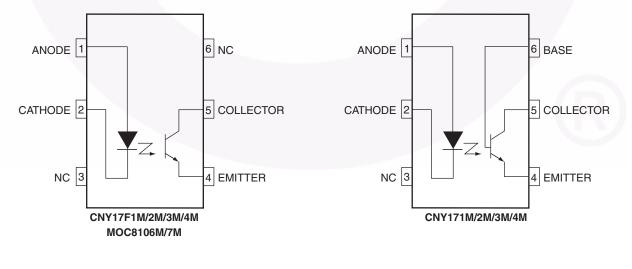
Description

The CNY17XM, CNY17FXM and MOC810XM devices consist of a Gallium Arsenide IRED coupled with an NPN phototransistor in a dual in-line package.

Package Outlines



Schematics



©2006 Fairchild Semiconductor Corporation CNY17XM, CNY17FXM, MOC810XM Rev. 1.1.1

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameters	Value	Units
TOTAL DE	VICE	-	•
T _{STG}	Storage Temperature	-40 to +150	°C
T _{OPR}	Operating Temperature	-40 to +100	°C
T _J	Junction Temperature	-40 to +125	°C
T _{SOL}	Lead Solder Temperature	260 for 10 sec	°C
P _D	Total Device Power Dissipation @ 25°C (LED plus detector)	250	mW
	Derate Linearly From 25°C	2.94	mW/°C
EMITTER			•
I _F	Continuous Forward Current	60	mA
V _R	Reverse Voltage	6	V
I _F (pk)	Forward Current – Peak (1µs pulse, 300pps)	1.5	Α
P _D	LED Power Dissipation 25°C Ambient	120	mW
	Derate Linearly From 25°C	1.41	mW/°C
DETECTO	₹		
I _C	Continuous Collector Current	50	mA
V _{CEO}	Collector-Emitter Voltage	70	V
V _{ECO}	Emitter Collector Voltage	7	V
P _D	Detector Power Dissipation @ 25°C	150	mW
	Derate Linearly from 25°C	1.76	mW/°C

$\textbf{Electrical Characteristics} \; (T_{A} = 25^{\circ}\text{C Unless otherwise specified.})^{(1)}$

Individual Component Characteristics

Symbol	Parameters	Test Conditions	Device	Min.	Тур.	Max.	Units
EMITTER		1					•
V _F	Input Forward Voltage	I _F = 60mA	CNY17XM, CNY17FXM	1.0	1.35	1.65	V
		I _F = 10mA	MOC810XM	1.0	1.15	1.50	
СЛ	Capacitance	$V_F = 0 V, f = 1.0MHz$	All		18		pF
I _R	Reverse Leakage Current	V _R = 6V	All		0.001	10	μA
DETECTO	DR	•		•	•	•	•
BV _{CEO}	Breakdown Voltage Collector to Emitter	I _C = 1.0mA, I _F = 0	All	70	100		V
BV _{CBO}	Collector to Base	$I_C = 10\mu A, I_F = 0$	CNY171M/2M/3M/4M	70	120		
BV _{ECO}	Emitter to Collector	$I_E = 100 \mu A, I_F = 0$	All	7	10		
I _{CEO}	Leakage Current Collector to Emitter	V _{CE} = 10 V, I _F = 0	All		1	50	nA
I _{CBO}	Collector to Base	V _{CB} = 10 V, I _F = 0	CNY171M/2M/3M/4M			20	nA
C _{CE}	Capacitance Collector to Emitter	V _{CE} = 0, f = 1MHz	All		8		pF
C _{CB}	Collector to Base	$V_{CB} = 0$, $f = 1MHz$	CNY171M/2M/3M/4M		20		pF
C _{EB}	Emitter to Base	V _{EB} = 0, f = 1MHz	CNY171M/2M/3M/4M		10		pF

Isolation Characteristics

Symbol	Characteristic	Test Conditions	Min.	Тур.*	Max.	Units
V _{ISO}	Input-Output Isolation Voltage	f = 60 Hz, t = 1 sec., $I_{I-O} \le 2\mu A^{(4)}$	7500			Vac(pk)
R _{ISO}	Isolation Resistance	$V_{I-O} = 500 \text{ VDC}^{(4)}$	10 ¹¹			Ω
C _{ISO}	Isolation Capacitance	$V_{I-O} = \emptyset$, f = 1MHz ⁽⁴⁾		0.2		pF

Transfer Characteristics ($T_A = 25^{\circ}C$ Unless otherwise specified.)⁽³⁾

Symbol	DC Characteristics		Test Conditions	Min.	Тур.*	Max.	Units
COUPLE	D			'			
(CTR) ⁽²⁾	(CTR) ⁽²⁾ Output Collector Current	MOC8106M	I _F = 10mA, V _{CE} = 10V	50		150	%
		MOC8107M		100		300	ĺ
		CNY17F1M	I _F = 10mA, V _{CE} = 5V	40		80	
		CNY17F2M		63		125	
	CNY17F3M		100		200		
		CNY17F4M		160		320	
		CNY171M		40		80	
		CNY172M		63		125	ĺ
		CNY173M		100		200	
		CNY174M		160		320	
V _{CE(sat)}	Collector-Emitter	CNY17XM/FXM	$I_C = 2.5 \text{mA}, I_F = 10 \text{mA}$			0.4	V
	Saturation Voltage	MOC8106M/7M	$I_C = 500\mu A, I_F = 5.0mA$				

^{*}All typicals at $T_A = 25$ °C

Electrical Characteristics (Continued) (T_A = 25°C Unless otherwise specified.)⁽¹⁾

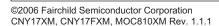
Transfer Characteristics (Continued)(3)

Symbol	AC Characteristics ⁽⁴⁾		Test Conditions	Min.	Тур.*	Max.	Units
NON-SAT	URATED SWITC	HING TIME					
t _{on}	Turn-On Time	All Devices	$I_C = 2.0$ mA, $V_{CC} = 10$ V, $R_L = 100\Omega$		2	10	μs
t _{off}	Turn-Off Time	All Devices	$I_C = 2.0 \text{mA}, V_{CC} = 10 \text{V}, R_L = 100 \Omega$		3	10	μs
t _d	Delay Time	CNY17XM/XFM	$I_F = 10$ mA, $V_{CC} = 5$ V, $R_L = 75\Omega$			5.6	μs
t _r	Rise Time	All Devices	$I_C = 2.0 \text{mA}, V_{CC} = 10 \text{V}, R_L = 100 \Omega$		1		μs
		CNY17XM/FXM	$I_F = 10 \text{mA}, V_{CC} = 5 \text{V}, R_L = 75 \Omega$			4.0	
t _s	Storage Time	CNY17XM/FXM	$I_F = 10 \text{mA}, V_{CC} = 5 \text{V}, R_L = 75 \Omega$			4.1	μs
t _f	Fall Time	All Devices	$I_C = 2.0 \text{mA}, V_{CC} = 10 \text{V}, R_L = 100 \Omega$		2		μs
		CNY17XM/FXM	$I_F = 10 \text{mA}, V_{CC} = 5 \text{V}, R_L = 75 \Omega$			3.5	
SATURA	TED SWITCHING	TIMES		'			
t _{on}	Turn-on Time	CNY171M/F1M	$I_F = 20$ mA, $V_{CC} = 5$ V, $R_L = 1$ k Ω			5.5	μs
		CNY172M/3M/4M CNY17F2M/F3M/F4M	$I_F = 10$ mA, $V_{CC} = 5$ V, $R_L = 1$ k Ω			8.0	
t _r	Rise Time	CNY171M/F1M	$I_F = 20$ mA, $V_{CC} = 5$ V, $R_L = 1$ k Ω			4.0	μs
		CNY172M/3M/4M CNY17F2M/F3M/F4M	$I_F = 10$ mA, $V_{CC} = 5$ V, $R_L = 1$ k Ω	V.		6.0	
t _d	Delay Time	CNY171M/F1M	$I_F = 20$ mA, $V_{CC} = 5$ V, $R_L = 1$ k Ω			5.5	μs
		CNY172M/3M/4M CNY17F2M/F3M/F4M	$I_F = 10$ mA, $V_{CC} = 5$ V, $R_L = 1$ k Ω			8.0	
t _{off}	Turn-off Time	CNY171M/F1M	I _F = 20mA, V _{CE} = 0.4V			34	μs
		CNY172M/3M/4M CNY17F2M/F3M/F4M	I _F = 10mA, V _{CE} = 0.4V			39	
t _f	Fall Time	CNY171M/F1M	$I_F = 20$ mA, $V_{CC} = 5$ V, $R_L = 1$ k Ω			20.0	μs
		CNY172M/3M/4M CNY17F2M/F3M/F4M	$I_F = 10$ mA, $V_{CC} = 5$ V, $R_L = 1$ k Ω			24.0	
t _s	Storage Time	CNY171M/F1M	$I_F = 20$ mA, $V_{CC} = 5$ V, $R_L = 1$ k Ω			34.0	μs
		CNY172M/3M/4M CNY17F2M/F3M/F4M	$I_F = 10$ mA, $V_{CC} = 5$ V, $R_L = 1$ k Ω			39.0	

^{*}All typicals at T_A = 25°C

Notes:

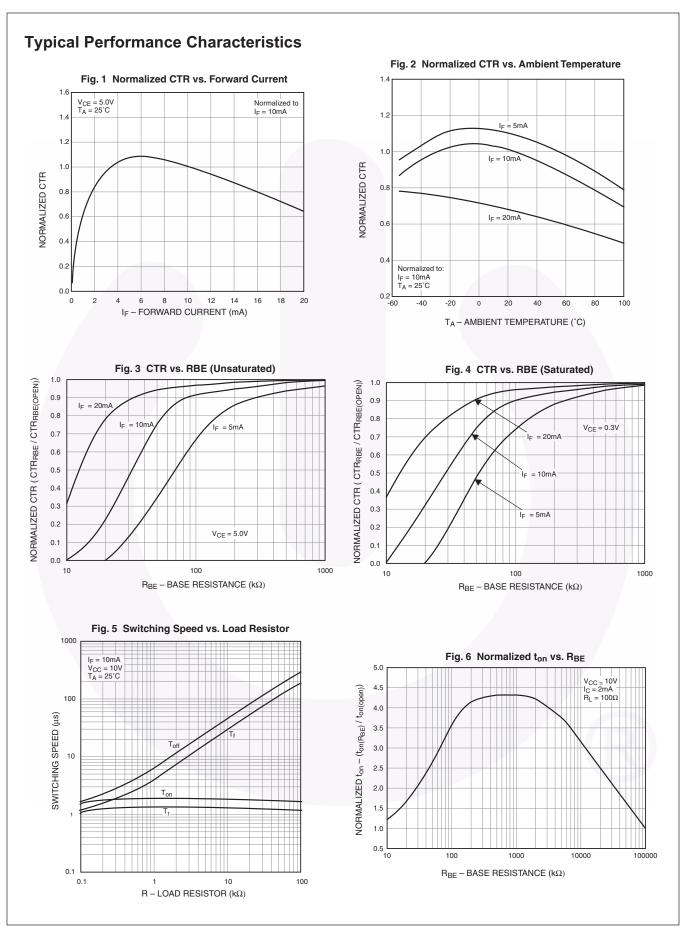
- 1. Always design to the specified minimum/maximum electrical limits (where applicable).
- 2. Current Transfer Ratio (CTR) = $I_C/I_F \times 100\%$.
- 3. For test circuit setup and waveforms, refer to Figures 10 and 11.
- 4. For this test, Pins 1 and 2 are common, and Pins 4 are 5 are common.



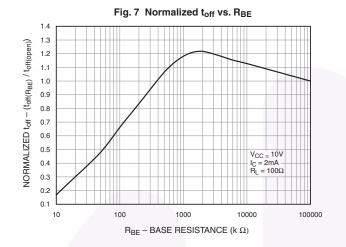
Safety and Insulation Ratings

As per IEC 60747-5-2, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Symbol	Parameter	Min.	Тур.	Max.	Unit
	Installation Classifications per DIN VDE 0110/1.89 Table 1				
	For Rated Main Voltage < 150Vrms		I-IV		
	For Rated Main voltage < 300Vrms		I-IV		
	Climatic Classification		55/100/21		
	Pollution Degree (DIN VDE 0110/1.89)		2		
CTI	Comparative Tracking Index	175			
V _{PR}	Input to Output Test Voltage, Method b, V _{IORM} x 1.875 = V _{PR} , 100% Production Test with tm = 1 sec, Partial Discharge < 5pC	1594			V _{peak}
	Input to Output Test Voltage, Method a, V _{IORM} x 1.5 = V _{PR} , Type and Sample Test with tm = 60 sec, Partial Discharge < 5pC				V _{peak}
V _{IORM}	Max. Working Insulation Voltage Vpeak	850			V _{peak}
V_{IOTM}	Highest Allowable Over Voltage Vpeak	6000			V _{peak}
	External Creepage	7			mm
	External Clearance	7			mm
	Insulation Thickness	0.5			mm
RIO	Insulation Resistance at Ts, V _{IO} = 500V	10 ⁹			Ω



Typical Performance Characteristics (Continued)



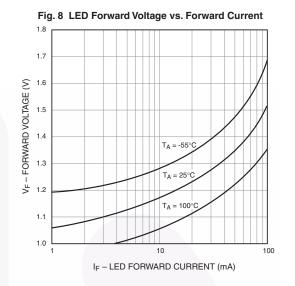
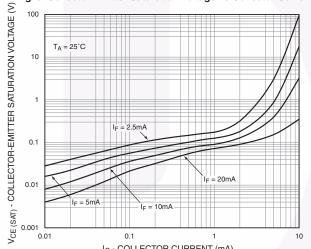


Fig. 9 Collector-Emitter Saturation Voltage vs Collector Current 10 0.1 = 20mA 0.01 I_C - COLLECTOR CURRENT (mA)



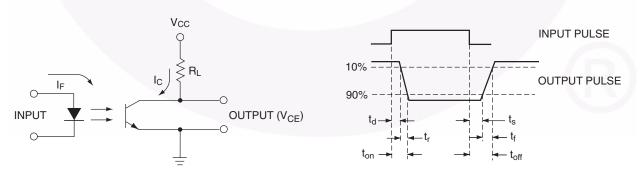
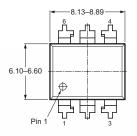


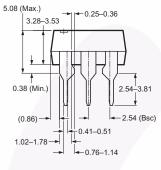
Figure 10. Switching Time Test Circuit

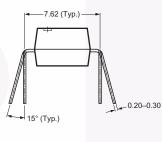
Figure 11. Switching Time Waveforms

Package Dimensions

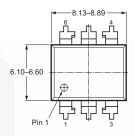
Through Hole

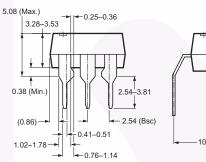


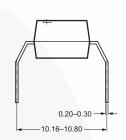




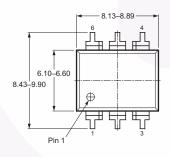
0.4" Lead Spacing

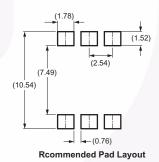


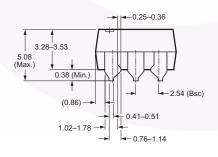


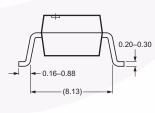


Surface Mount







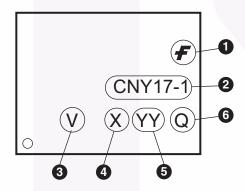


Note: All dimensions in mm.

Ordering Information

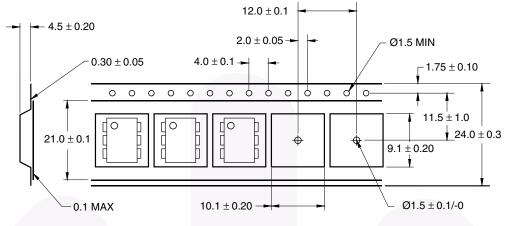
Option	Order Entry Identifier (Example)	Description
No option	CNY171M	Standard Through Hole Device
S	CNY171SM	Surface Mount Lead Bend
SR2	CNY171SR2M	Surface Mount; Tape and Reel
Т	CNY171TM	0.4" Lead Spacing
V	CNY171VM	IEC60747-5-2
TV	CNY171TVM	IEC60747-5-2, 0.4" Lead Spacing
SV	CNY171SVM	IEC60747-5-2, Surface Mount
SR2V	CNY171SR2VM	IEC60747-5-2, Surface Mount, Tape and Reel

Marking Information



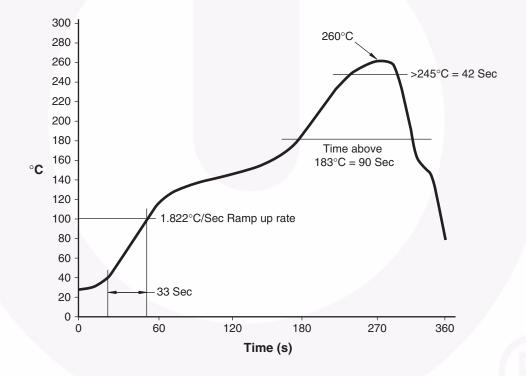
Definitions					
1	Fairchild logo				
2	Device number				
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)				
4	One digit year code, e.g., '7'				
5	Two digit work week ranging from '01' to '53'				
6	Assembly package code				

Carrier Tape Specification



User Direction of Feed -----

Reflow Profile







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Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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